

TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

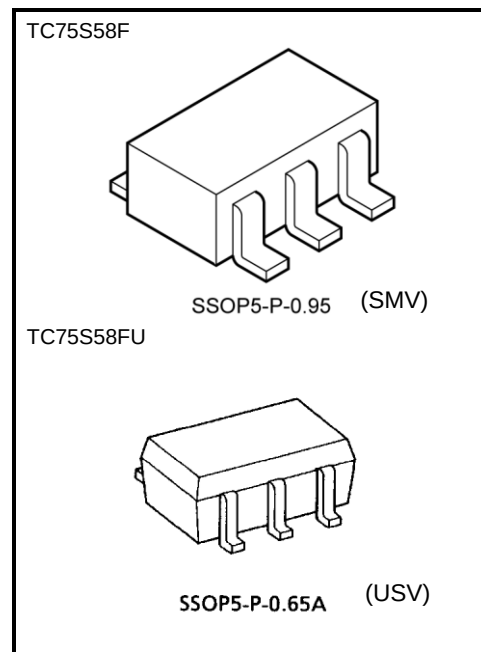
TC75S58F, TC75S58FU

Single Comparator

The TC75S58F/TC75S58FU is a CMOS general-purpose single comparator. The device can operate off a single power supply and draws a lower supply current than a conventional bipolar general-purpose comparator. This device's open-drain output stage can be wire-ORed with those of other open-drain output circuits.

Features

- Low-current power supply : $I_{DD} = 10 \mu A$ (typ.)
- Single power supply operation : $V_{DD} = \pm 0.9$ to ± 3.5 V or 1.8 to 7 V
- Wide common mode input voltage range : V_{SS} to $V_{DD} - 0.9$ V
- Open drain output circuit
- Low input bias current
- Small package

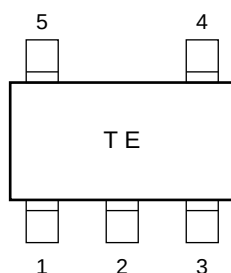


Weight

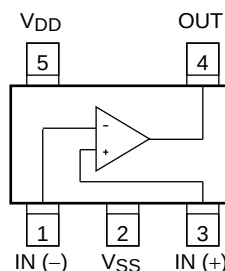
SSOP5-P-0.95 : 0.014 g (typ.)

SSOP5-P-0.65A : 0.006 g (typ.)

Marking (top view)



Pin Connection (top view)



Start of commercial production
1997-02

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{DD} , V _{SS}	±3.5 or 7	V
Differential input voltage	DV _{IN}	±7	V
Input voltage	V _{IN}	V _{SS} to V _{DD}	V
Output current	I _O	±35	mA
Power dissipation	P _D	200	mW
Operating temperature	T _{opr}	–40 to 85	°C
Storage temperature	T _{stg}	–55 to 125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: This device's CMOS structure makes it prone to latch-up. To prevent latch-up, please take the following precautions:

- Ensure that no I/O pin's voltage level ever exceeds V_{DD} or drops below V_{SS}.
In addition, check the power-on timing.
- Do not subject the device to excessive noise.

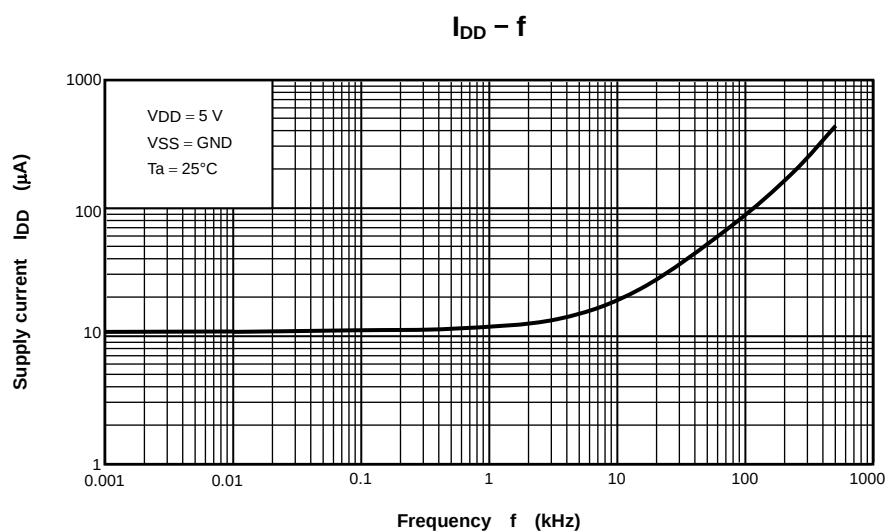
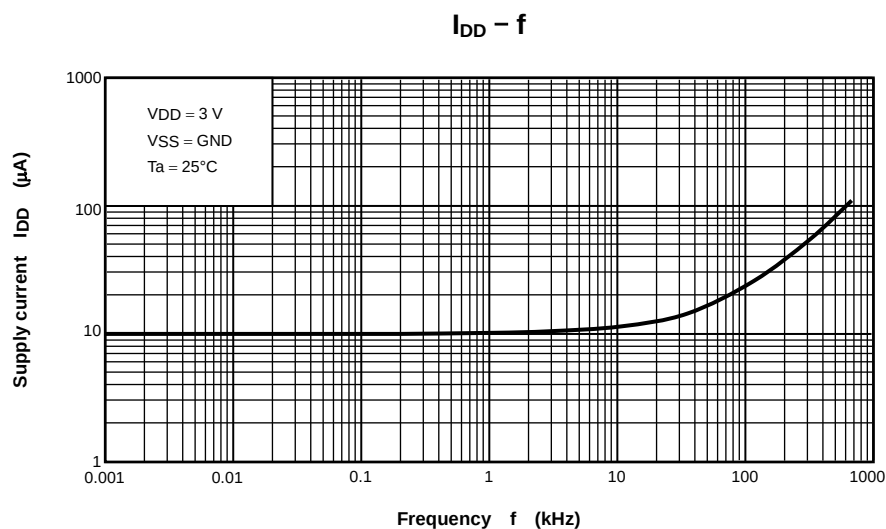
Electrical Characteristics ($V_{DD} = 5\text{ V}$, $V_{SS} = \text{GND}$, $T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Input offset voltage	V_{IO}	—	—	—	± 1	± 7	mV
Input offset current	I_{IO}	—	—	—	1	—	pA
Input bias current	I_I	—	—	—	1	—	pA
Common mode input voltage	CMV_{IN}	—	—	0	—	4.1	V
Supply current	I_{DD} (Note)	—	—	—	11	22	μA
Voltage gain	G_V	—	—	—	94	—	dB
Sink current	I_{sink}	—	$V_{OL} = 0.5\text{ V}$	13	25	—	mA
Output leak current	I_{LEAK}	—	$V_O = 5\text{ V}$	—	5	—	nA
Output voltage	V_{OL}	—	$I_{sink} = 5.0\text{ mA}$	—	0.1	0.3	V
Operating supply voltage	V_{DD}	—	—	1.8	—	7.0	V
Propagation delay time (turn on)	t_{PLH} (1)	—	Over drive = 100 mV	—	800	—	ns
	t_{PLH} (2)	—	TTL step input	—	620	—	
Propagation delay time (turn off)	t_{PHL} (1)	—	Over drive = 100 mV	—	230	—	ns
	t_{PHL} (2)	—	TTL step input	—	350	—	
Response time	t_{TLH}	—	Over drive = 100 mV	—	190	—	ns
	t_{THL}	—	Over drive = 100 mV	—	6	—	

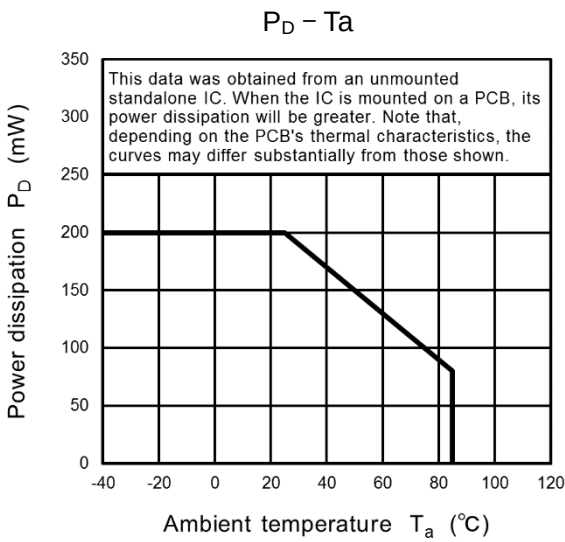
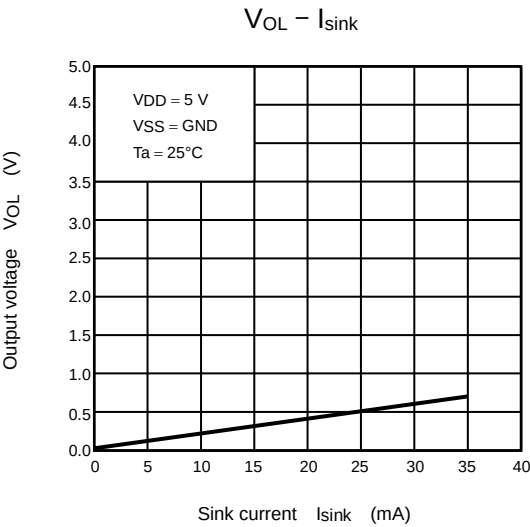
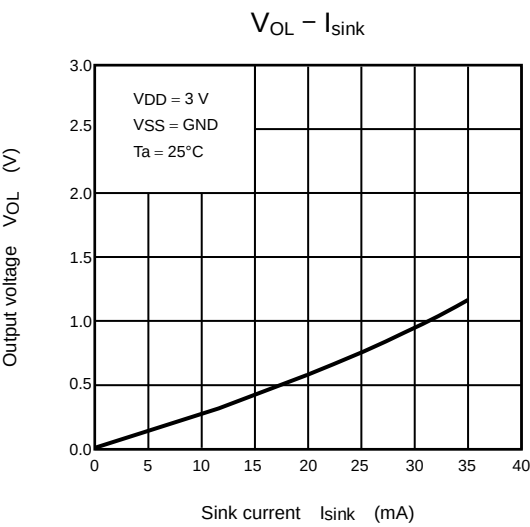
Electrical Characteristics ($V_{DD} = 3\text{ V}$, $V_{SS} = \text{GND}$, $T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Input offset voltage	V_{IO}	—	—	—	± 1	± 7	mV
Input offset current	I_{IO}	—	—	—	1	—	pA
Input bias current	I_I	—	—	—	1	—	pA
Common mode input voltage	CMV_{IN}	—	—	0	—	2.1	V
Supply current	I_{DD} (Note)	—	—	—	10	20	μA
Sink current	I_{sink}	—	$V_{OL} = 0.5\text{ V}$	6	18	—	mA
Output leak current	I_{LEAK}	—	$V_O = 3\text{ V}$	—	5	—	nA
Output voltage	V_{OL}	—	$I_{sink} = 5.0\text{ mA}$	—	0.15	0.35	V
Propagation delay time (turn on)	t_{PLH}	—	Over drive = 100 mV	—	590	—	ns
Propagation delay time (turn off)	t_{PHL}	—	Over drive = 100 mV	—	230	—	ns
Response time	t_{TLH}	—	Over drive = 100 mV	—	170	—	ns
	t_{THL}	—	Over drive = 100 mV	—	5	—	

Note: This device's current consumption increases as its operating frequency increases. Note that the power dissipation should not exceed the allowable power dissipation.



The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

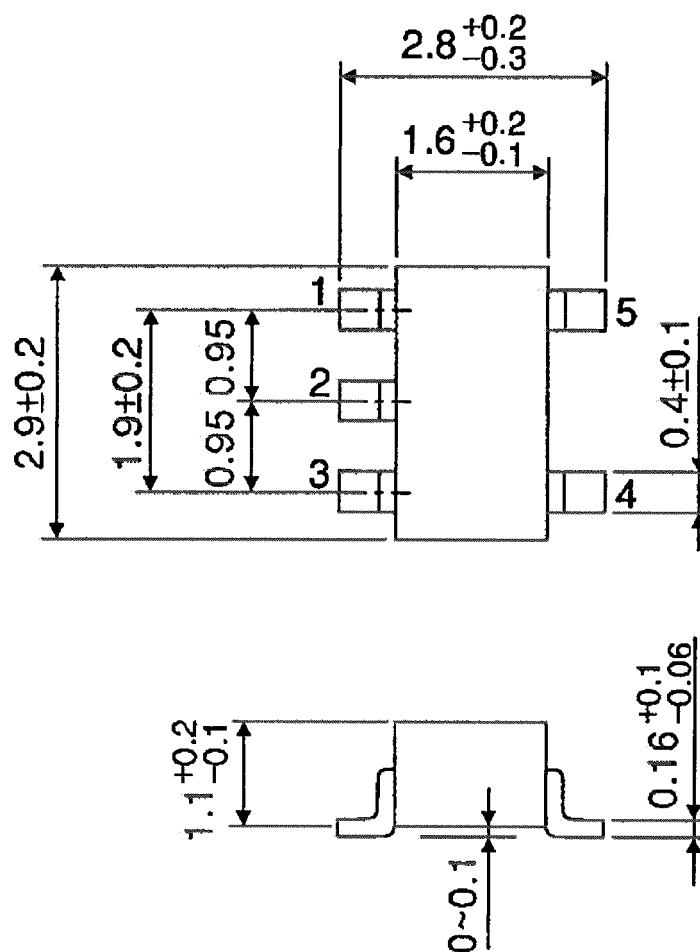


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Package Dimensions

SSOP5-P-0.95

Unit : mm

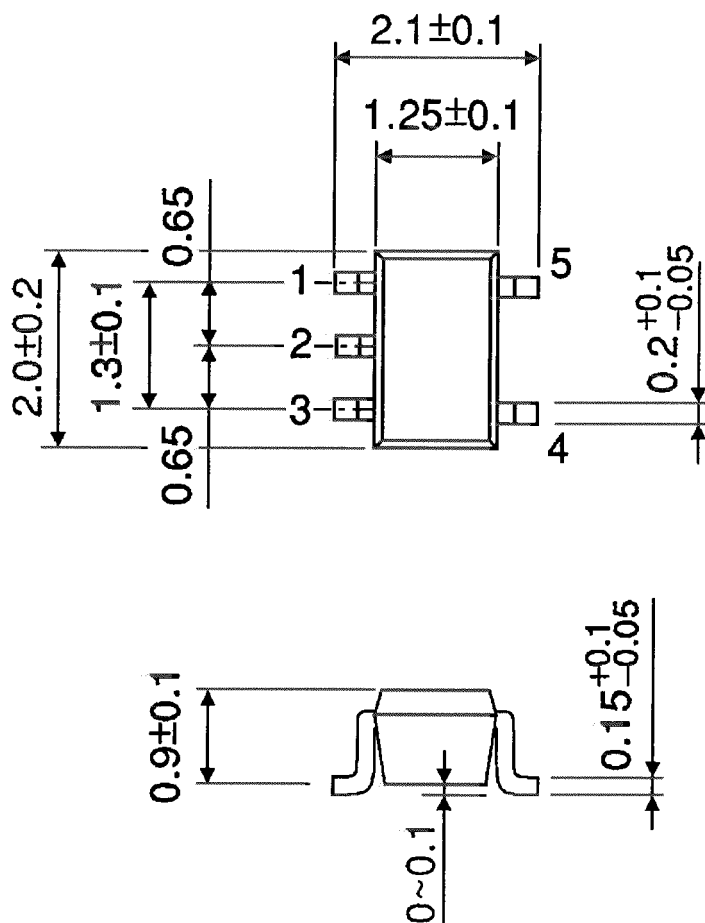


Weight: 0.014 g (typ.)

Package Dimensions

SSOP5-P-0.65A

Unit : mm



Weight: 0.006 g (typ.)

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